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[Reference](http://www.ti.com/tool/TIDA-01375?dcmp=dsproject&hqs=rd) Design

[TPS92830-Q1](http://www.ti.com.cn/product/cn/tps92830-q1?qgpn=tps92830-q1)

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TPS92830-Q1 3 通道大电流线性 **LED** 控制器

Technical [Documents](http://www.ti.com.cn/product/cn/TPS92830-Q1?dcmp=dsproject&hqs=td&#doctype2)

1 特性

- 符合 AEC-Q100 标准
	- 器件温度等级 1:环境运行温度范围为 -40°C 至 125°C
	- 器件人体放电模型 (HBM) 静电防护 (ESD) 分类 等级 H2
	- 器件组件充电模型 (CDM) ESD 分类等级 C4B
- 4.5V 至 40V 的宽电压输入范围
- 3 通道高侧电流驱动和检测
	- 通道独立的电流设置
	- 通道独立的 PWM 输入
	- 通过 PWM 输入和电源实现 PWM 调光
	- 针对 EMC 优化的压摆率
- 高精度 LED 驱动
	- 采用外部 N 沟道 MOSFET 的精密电流调节 (2.5% 容差)
	- 具有非板载 Bin 电阻支持的 20:1 模拟调光配置
	- 具有全占空比屏蔽的精密 PWM 发生器(2% 容 差)
	- 用于同步的开漏 PWM 输出
- • 保护和诊断
	- 用于外部 MOSFET 热保护的可调节输出电流降 额
	- 具有自动恢复功能的 LED 灯串开路或短路诊断
	- 针对低电压运行支持诊断并具有可调节阈值
	- 多达 15 个器件的故障总线,可配置为连带失效 或仅失效的通道关闭
	- 故障模式下具有较低的静态电流(每个器件小于 0.75mA)
- 工作结温范围: -40°C 至 150°C
- TSSOP 28 封装 (PW)

2 应用

- 后灯 尾灯和制动灯、后转向灯、雾灯、倒车灯
- 前灯 位置灯、日间行车灯、前转向灯、近光灯

3 说明

Tools & **[Software](http://www.ti.com.cn/product/cn/TPS92830-Q1?dcmp=dsproject&hqs=sw&#desKit)**

在实现更佳的灯光均匀性的趋势下,高电流 LED 通常 用于汽车前灯和后灯(配备灯光扩散器和导光板)。同 时, 为了满足严格的 EMC 和可靠性要求, 线性 LED 驱动器广泛用于汽车 应用。不过,通过集成功率晶体 管为线性 LED 驱动器提供高电流是一项挑战。 TPS92830-Q1 器件是一款先进的汽车级高侧恒定电流 线性 LED 控制器, 通过使用外部 N 沟道 MOSFET 提 供高电流。该器件具有一整套用于 汽车 应用的 功能, 并与各种 N 沟道 MOSFET 兼容。

Support & **[Community](http://www.ti.com.cn/product/cn/TPS92830-Q1?dcmp=dsproject&hqs=support&#community)**

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TPS92830-Q1 器件的每个通道可以通过感应电阻器值 独立设置通道电流。内部精密恒定电流调节环路通过感 应电阻器上的电压感应通道电流,并相应地控制 N 沟 道 MOSFET 的栅极电压。该器件还集成了一个两级电 荷泵,用于低压降运行。电荷泵电压足够高,可以支持 各种 N 沟道 MOSFET。PWM 调光允许使用多个

器件信息**[\(1\)](#page-0-0)**

(1) 要了解所有可用封装,请见数据表末尾的可订购产品附录。

简化原理图

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5 说明 (续)

源以实现灵活性 - 内部 PWM 发生器、外部 PWM 输入或电源调光。各种专为汽车应用 设计的 诊断和保护可 帮助 提高系统稳健性和易用性。连带失效故障总线支持 TPS92830-Q1 与 TPS92630-Q1、TPS92638-Q1 和 TPS9261x-Q1 系列一同运行,以满足各种故障处理要求。

6 Pin Configuration and Functions

Pin Functions

Pin Functions (continued)

7 Specifications

7.1 Absolute Maximum Ratings

over operating junction temperature range T_{J} = -40°C to 150°C (unless otherwise noted)⁽¹⁾

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages are with respect to GND.

(3) Absolute maximum voltage 45 V for 200 ms.

7.2 ESD Ratings

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

7.3 Recommended Operating Conditions

over operating junction temperature range T_J = -40°C to 150°C (unless otherwise noted)

7.4 Thermal Information

(1) For more information about traditional and new thermal metrics, see *[Semiconductor](http://www.ti.com/cn/lit/pdf/SPRA953) and IC Package Thermal Metrics*.

7.5 Electrical Characteristics

 V_{IN} = 5 V to 40 V, V_{ICTRL} = 3 V, V_{DERATE} = 0 V, T_J = -40°C to 150°C,⁽¹⁾ (unless otherwise noted)

(1) External N-channel MOSFET C_{iss} = 200 pF, C_{oss} = 70 pF, at V_{DS} = 25 Vdc, V_{GS} = 0 Vdc, f = 1 MHz, V_{th}= 4 V, compensation capacitor $\rm C_{gs}$ = 4 nF

$$
\Delta V_{\text{(CS_Channel_CHx)}} = 1 - \frac{3 \times V_{\text{(CS_REG_x)}}}{\left(V_{\text{(CS_REG_1)}} + V_{\text{(CS_REG_2)}} + V_{\text{(CS_REG_3)}}\right)}, x = 1, 2, 3
$$
\n
$$
\Delta V_{\text{(CS_Device_CHx)}} = 1 - \frac{V_{\text{(CS_REG_x)}}}{0.295}, x = 1, 2, 3
$$

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INSTRUMENTS

TEXAS

Electrical Characteristics (continued)

Electrical Characteristics (continued)

7.6 Timing Requirements

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图 **1. Channel-Current Output Timing Diagram**

7.7 Typical Characteristics

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Typical Characteristics (接下页**)**

 $T_A = 25$ °C unless otherwise noted

Typical Characteristics (接下页**)**

8 Detailed Description

8.1 Overview

The TPS92830-Q1 device is an advanced automotive-grade high-side constant-current linear LED controller for delivering high current using external N-channel MOSFETs. The device has a full set of features for automotive applications. Each channel of the TPS92830-Q1 device sets the channel current independently by the senseresistor value. An internal precision constant-current regulation loop senses the channel current by the voltage across the sense resistor and controls the gate voltage of the N-channel MOSFET accordingly. The device also integrates a two-stage charge pump for low-dropout operation. The charge-pump voltage is high enough to support a wide selection of N-channel MOSFETs. PWM dimming allows multiple sources for flexibility—internal PWM generator, external PWM inputs, or power-supply dimming. Various diagnostics and protection features specially designed for automotive applications help improve system robustness and ease of use. A one-fails–allfail fault bus supports TPS92830-Q1 operation together with the TPS92630-Q1, TPS92638-Q1, and TPS9261x-Q1 family to fulfill various fault-handling requirements.

SUPPLY C P1N \rightarrow CP1P CP2N \rightarrow CP2P \rightarrow CPOUT TPS92830-Q1 CURRENT IN REGULATION Charge Pump DRIVER X3 **ICTRL** ISP Analog DERATE Dimming R_{SNSx} Current Sense DIAGEN ISNx PWM1 MNx Gx Н Gate Driver PWM2 Clamp Control SENSEx Logic Diagnostics PWM3 IREF PWMCHG PWM ≷ Generator FD Temperature Sensor PWMOUT FAULT Bus FAULT Input / Output GND

8.2 Functional Block Diagram

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8.3 Feature Description

The TPS92830-Q1 device uses IN voltage to generate device bias. A two-stage charge pump provides gate driving voltage above the IN voltage for the high-side N-channel MOSFET. Each channel current is independently set by sense resistors. The analog-dimming ICTRL input supports off-board resistors as binsetting resistors as well as direct voltage input. An integrated precision PWM generator could be used for PWM dimming locally.

8.3.1 Device Bias

The TPS92830-Q1 device has internal bias-generation and power-on-reset circuits for internal bias.

8.3.1.1 Power-On-Reset (POR)

The TPS92830-Q1 device has an internal power-on-reset (POR) function. When power is applied to IN, the internal POR holds the device in the reset condition until V_{IN} reaches $V_{(POR)$ rising).

When the supply rises above POR threshold $V_{(POR_rising)}$, the charge pump starts working. The maximum gatedrive voltage is determined by the charge-pump voltage between CPOUT and IN.

8.3.1.2 Current Reference (IREF)

The TPS92830-Q1 device has a constant reference-voltage output on the IREF pin and uses current $I_{(IREF)}$ as the internal current reference. The analog-dimming internal-pullup current on ICTRL, and the PWM-generator internal charge current on PWMCHG, use $I_{(IREF)}$ as a reference current. The recommended value of reference resistor $R_{(IREF)}$ for IREF is 8 kΩ.

8.3.1.3 Low-Current Fault Mode

The TPS92830-Q1 device consumes minimal quiescent current when it is in fault mode. If the FAULT voltage is pulled low either by internal diagnostics or externally, the device performs as follows:

- The charge pump is shut down.
- All drivers are turned off with their gates internally pulled down.
- The PWM generator and PWMOUT are turned off.
- IREF current is turned off.
- ICTRL current is turned off.

8.3.2 Charge Pump

8.3.2.1 Charge Pump Architecture

The TPS92830-Q1 device uses a two-stage charge pump to generate the high-side gate-drive voltage. The charge pump is a voltage tripler using external flying and storage capacitors.

 C_{P1} is the first-stage flying capacitor, connected between CP1P and CP1N, which are the positive and negative nodes, respectively. C_{P2} is the second-stage flying capacitor, connected between CP2P and CP2N, which are the positive and negative nodes, respectively. C_S is the storage capacitor, connected between CPOUT and IN. C_S stores charge for the high-side gate driver.

The charge pump switches at frequency $f_{(cp sw)}$ to optimize EMI performance.

Negative nodes CP1N and CP2N are driven by a 5-V driver, thus the maximum voltage on charge-pump output node CPOUT is approximately V_(IN) + V_(CP drv). The charge pump voltage across storage capacitor C_S is not dependent on $V_{(IN)}$.

图 **20. Charge Pump**

8.3.3 Constant-Current Driving

The TPS92830-Q1 device has three independent constant-current driving channels. Each channel sets channel current with an external high-side current-sense resistor, R_{SNSx} . Channel current is set as $V_{(CS-REG)} / R_{SNSx}$.

Considering that both ICTRL and DERATE voltages reduce current-sense voltage $V_{(CS|REG)}$ independently, channel current can be calculated using the following equation. Each of the dimming ratios is described separately in following sections.

$$
I_{(CHx)} = \frac{V_{(CS_REG_FULL)} \times k_{(ICTRL_DIM)} \times k_{(DERATE_DIM)}}{R_{SNSx}}
$$
\n(1)

8.3.3.1 High-Side Current Sense

The sense voltage across external current-sense resistor R_{SNSX} feeds back current information to the controller. An internal feedback control loop within the TPS92830-Q1 device regulates the external gate-overdrive voltage of the N-channel MOS transistor to keep the sense voltage at the desired level. By setting the external currentsense resistance value, the output current can be set individually on each channel.

8.3.3.2 High-Side Current Driving

To regulate the output current, the gate-source voltage of the external MOSFET must be regulated accordingly. The constant-current source is used to charge and discharge the N-channel MOSFET gate. During the currentslewing period, constant-current sourcing and sinking ensures the smooth slewing of the output current. The control loop requires sufficient MOSFET gate capacitance to ensure loop stability. In case the MOSFET gate capacitance is insufficient, a capacitor C_{GS} must be added across Gx and SENSEx. TI also recommends always putting a C_{SENSE} of 10 nF from each of the SENSEx pins to GND, and close to the device for EMC.

When a channel is switched on, current source $I_{(DRV\ source)}$ charges the gate of the external N-channel MOSFET. When a channel is switched off, current sink I_{ORV} sink) discharges the gate of the external MOSFET transistor down to ground.

图 **21. MOSFET Gate Capacitance Compensation**

8.3.3.3 Gate Overdrive Voltage Protection

A bidirectional clamp is used to protect the gate-source path of the external N-channel MOSFETs from overstress conditions. Gate-source voltage $V_{(GS)}$ is clamped between $V_{(GS\text{ clamp}\text{ ned})}$ and $V_{(GS\text{ clamp}\text{ pos})}$ for MOSFET protection.

8.3.3.4 High-Precision Current Regulation

The TPS92830-Q1 device has a high-precision current-regulation loop. Its precision is at the maximum when the voltage across the current-sense resistor is set to maximum. The analog-dimming or current-derating function reduces the current-sense voltage, thus decreasing current-regulation accuracy.

8.3.3.5 Parallel MOSFET Driving

The TPS92830-Q1 device is designed to support parallel N-channel MOSFETs driving within the same channel. To balance heat dissipation, multiple MOSFETs could be paralleled together. A ballast resistor for each MOSFET is recommended to balance current distribution among parallel MOSFETs.

Larger variation on threshold mismatches requires larger ballast resistors. $V_{(TH~MISMATCH)}$ is the threshold for mismatches within the same batch of MOSFETs. $I_{\text{[CH_MISMATCH]}}$ is the allowed mismatch current between the parallel channels. Typically, I_(CH MISMATCH) can be set to 10% of full-range current. The ballast resistor value is set as calculated in the following equation.

$$
R_{(Ballast)} = \frac{V_{(TH_MISMATCH)}}{I_{(CH_MISMATCH)}}
$$

(2)

The ballast resistor typically ranges from hundreds of milliohms to several ohms depending on the channel current and MOSFET threshold-voltage variations.

图 **22. Parallel MOSFET Driving**

8.3.4 PWM Dimming

The TPS92830-Q1 device supports a variety of PWM dimming methods, including PWM supply dimming, external PWM dimming by inputs, and internal PWM dimming by the internal PWM generator. Each PWM cycle should allow enough positive cycle time for gate charging and enough negative cycle time for gate discharging in order to achieve an accurate PWM dimming duty cycle.

8.3.4.1 Supply Dimming

In the case of supply dimming, the supply of the whole LED driver module is PWM dimmed, for example by body-control-module (BCM) high-side switches. The TPS92830-Q1 device supports supply dimming with a short power-on delay. Device supply V_{IN} should be always equal to V_(ISP) to ensure that the charge pump voltage is high enough to turn on the MOSFET.

When supply dimming is used, it is recommended to be used together with PWM input, so that the channel is only turned on when the input voltage is above the device UVLO threshold. By keeping enough delay time between device power up and channel turnon, output current spikes can be avoided to ease EMC design.

8.3.4.2 PWM Dimming by Input

Each channel has individual PWM dimming by inputs.

The internal thresholds for PWM1–PWM3 are designed with high precision. With external resistor dividers, each channel threshold can be set flexibly and independently.

8.3.4.3 Internal Precision PWM Generator

The TPS92830-Q1 device has an integrated precision PWM generator for on-chip PWM dimming as shown in . The device supports open-drain PWMOUT for synchronization between devices. Each device can be connected as a master, generating PWM, or as a slave, relying on external PWM sources. An external RC circuit precisely sets the duty cycle of the PWM generator across a wide duty-cycle range. Variation of the capacitor value affects the output frequency but not the duty cycle.

The PWM generator uses reference current 2 \times I_(IREF) as the internal charge current, I_(PWMCHG).

When V_(PWMCHG) increases above rising threshold V_(PWMCHG_th_rising), the constant-current source is turned off and $\rm V_{(PWMCHG)}$ decays through the external resistor-capacitor circuit. The PWM output is set LOW. The PWMCHG threshold is set to V_(РWMCHG_th_falling). When V_(РWMCHG) decreases below falling threshold V_(РWMCHG_th_falling), the constant-current source is turned on again to charge up the external capacitor. The PWM output is HIGH and the threshold is set to $V_{(PWMCHG_tth_rising)}$.

图 **23. PWM Generator Dual-Brightness Configuration**

An external resistor $R_{(PWMEXT)}$ and capacitor $C_{(PWMEXT)}$ are used to set the PWM cycle time.

$$
t_{(PWM_ON)} = R_{(PWMEXT)} \times C_{(PWMEXT)} \times ln\left(\frac{V_{(PWMCHG_th_falling)} - I_{(PWMCHG)} \times R_{(PWMEXT)}}{V_{(PWMCHG_th_rising)} - I_{(PWMCHG)} \times R_{(PWMEXT)}}\right)
$$
\n
$$
t_{(PWM_OFF)} = R_{(PWMEXT)} \times C_{(PWMEXT)} \times ln\left(\frac{V_{(PWMCHG_th_rising)}}{V_{(PWMCHG_th_falling)}}\right)
$$
\n
$$
t_{(PWMEXT)} = \frac{1}{\sqrt{V_{(PWMCHG_th_falling)}}}
$$
\n(4)

$$
R_{(PWMEXT)} \times C_{(PWMEXT)} \times C_{(PWMEXT)} \times \left[ln \left(\frac{V_{(PWMCHG_th_falling)} - I_{(PWMCHG)} \times R_{(PWMEXT)}}{V_{(PWMCHG_th_rising)} - I_{(PWMCHG)} \times R_{(PWMEXT)}} \right) + ln \left(\frac{V_{(PWMCHG_th_falling)}}{V_{(PWMCHG_th_falling)}} \right) \right]
$$
\n
$$
D_{(PWMEXT)} = \frac{ln \left(\frac{V_{(PWMCHG_th_falling)} - I_{(PWMCHG)} \times R_{(PWMEXT)}}{V_{(PWMCHG_th_falling)} - I_{(PWMCHG)} \times R_{(PWMEXT)}} \right)} \times \frac{ln \left(\frac{V_{(PWMCHG_th_falling)} - I_{(PWMCHG_t_RF,ring)}}{V_{(PWMCHG_th_falling)} - I_{(PWMCHG)} \times R_{(PWMEXT)}} \right)} \times \frac{ln \left(\frac{V_{(PWMCHG_th_falling)}}{V_{(PWMCHG_th_falling)}} \right)}{V_{(PWMCHG_th_falling)} - I_{(PWMCHG)} \times R_{(PWMEXT)}} \right)
$$
\n
$$
(6)
$$

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图 **24. PWM Dimming Profile**

8.3.4.4 Full Duty-Cycle Switch

The TPS92830-Q1 device can flexibly switch between the internal PWM modulation mode and the 100% dutycycle mode by using the FD input. Once $V_{(FD)}$ is higher than threshold $V_{H(FD)}$, the internal PWM generator is bypassed and output is merely controlled by the PWM inputs.

If FD is HIGH, the PWMCHG current source is turned off and $V_{(PWMCHG)}$ decays to GND through the external resistor-capacitor circuit. When FD falls below the threshold, $V_{(PWMCHG)}$ increases from GND due to the internal charge current.

If FD is HIGH, PWM generator oscillation stops, and PWMOUT is controlled by PWM1 only.

External PWM inputs and internal PWM inputs are combined together for channel PWM dimming, or external PWM inputs can be used as channel enable inputs.

图 **25. PWM Dimming Internal Block Diagram**

表 **1. Truth Table When Driving With PWM**

表 **2. Truth Table When Driving With PWMOUT**

8.3.5 Analog Dimming

The TPS92830-Q1 device has a linear analog input pin, ICTRL, for output-current dimming. Voltage across the sense resistors is linearly reduced if the ICTRL input voltage $V_{(ICTRL)}$ decreases. Analog dimming can be used for brightness control, LED bin brightness correction, and thermal protection with a thermistor. ICTRL also supports off-board connection for LED binning and thermistor connection.

8.3.5.1 Analog Dimming Topology

Voltage at the ICTRL pin, V_(ICTRL), is used for analog dimming control. To set V_(ICTRL), either a reference input voltage can be applied or a resistor between ICTRL and GND can be used.

When $V_{(ICTRL)}$ is greater than $V_{(ICTRL_FULL)}$, analog dimming is not enabled; thus the analog dimming ratio is at 100%.

When $\rm V_{(ICTRL)}$ is between $\rm V_{(ICTRL_LLN_BOT)}$ and $\rm V_{(ICTRL_LLN_TOP)}$, the analog dimming ratio is directly proportional to $\rm V_{(ICTRL)}$. The analog dimming ratio can be calculated using the following equation. $\rm V_{(ICTRL_LIN_BOT)}$ and $V_{\text{ICTRL/LIN TOP}}$ represent the ICTRL voltage boundaries of the linear region.

$$
k_{(ICTRL_DIM)} = \frac{V_{(ICTRL)}}{1.475 \text{ V}} \times 100\%
$$

(7)

When V_{ICTRL} is between V_(ICTRL_LIN_TOP) and V_(ICTRL_FULL) or between V_(ICTRL_LIN_BOT) and 0, analog dimming is in a transition region, and linearity is not assured. Thus it is not recommended to use ICTRL in these regions.

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图 **26. Analog Dimming Ratio**

8.3.5.2 Internal High-Precision Pullup Current Source

An internal precision pullup current I_(ICTRL_pullup) is provided within the device to minimize external component count. I_(ICTRL_pullup) uses current reference I_(IREF) as reference. With the internal pullup current source, only an external resistor between the ICTRL pin and GND is needed to set the ICTRL voltage and the analog dimming ratio.

If a voltage source or resistor divider is used, the internal pullup current must be taken into account to set the analog dimming ratio accurately.

The pullup current source pulls the ICTRL pin voltage up to input voltage $V_{(IN)}$ if the ICTRL pin is unconnected. When ICTRL is not used, it is recommended to leave the ICTRL pin floating.

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图 **27. Internal High-Precision Pullup Current Source**

8.3.6 Output Current Derating

The TPS92830-Q1 device has an integrated output-current derating function. Voltage across the sensing resistors is reduced if DERATE input voltage V_{DERATE} increases. The output current derating function can be used for supply overvoltage protection and thermal protection with a thermistor. The DERATE current curves are divided into 32 steps between 100% and 50% with hysteresis.

In the case where DERATE is used for battery voltage sensing, the resistor-divider ratio can be set in a typical application as follows.

- In the normal supply-voltage range, for example, (9 V-16 V), the output-current-derating function is disabled.
- In the overvoltage range, for example, (18 V–24 V), the output current starts to derate and reaches 50% when V_{IN} is at 24 V.
- When the voltage is even higher, for example, (24 V–26 V), the output current is saturated at 50%.

8.3.6.1 Output-Current Derating Topology

Voltage at the DERATE pin, $V_{\text{(DERATE)}}$, is used for output-current-derating control. To set the $V_{\text{(DERATE)}}$ voltage, a resistor divider on supply voltage V_{IN} is typically used for supply overvoltage protection.

- When V_{DERATE} is lower than $V_{(DERATE_FULL)}$, output current derating is not enabled; thus, output-current derating ratio $k_{\text{(DERATE-Dim)}}$ is at 100%.
- When V_{DERATE} is higher than $V_{IDERATE}$ HALF), output current derating is limited to 50%; thus, output-current derating ratio $k_{\text{(DERATE-Dim)}}$ is at 50%.
- When $V_{(DERATE)}$ is between $V_{(DERATE_FULL)}$ and $V_{(DERATE_HALF)}$, the output-current-derating ratio is negatively proportional to V_(DERATE) with 32 steps. Current derating is rounded to the next-lower step. The output-currentderating ratio can be calculated using the following equations.

$$
V_{\text{(DERATE_STEP)}} = \frac{V_{\text{(DERATE_HALF)}} - V_{\text{(DERATE_FULL)}}}{32}
$$
\n
$$
k_{\text{(DERATE_Dim)}} = 100\% - \left(\frac{V_{\text{(DERATE)}} - V_{\text{(DERATE_FULL)}}}{V_{\text{(DERATE_STEP)}}}\right) \times \frac{50\%}{32}
$$
\n(9)

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EXAS NSTRUMENTS

图 **28. Output-Current Derating Profile**

8.3.7 Diagnostics and Fault

The TPS92830-Q1 device provides advanced diagnostics and fault protection methods for automotive exterior lighting systems. The device is able to detect and protect from LED output short-to-GND as well as from LED output open-circuit scenarios. The device also supports a one-fails–all-fail fault bus that could flexibly fit different legislative requirements.

图 **29. LED Open and Short Scenarios**

8.3.7.1 LED Short-to-GND Detection

The TPS92830-Q1 device has channel-independent LED short-to-GND detection. Short-to-GND detection is only enabled during channel on-time. Once an LED short-to-GND failure is detected, the device turns off the faulty channel and retries automatically. If the auto-retry mechanism detects that the LED short-to-GND fault has been removed, the device resumes normal operation. section

The device monitors voltage $\rm V_{\rm (SENSEx)}$ and compares it with the internal reference voltage to detect short-to-GND failures. If the period during which V $_{\rm (SENSEx)}$ falls below V $_{\rm (SG_th_rising)}$ is longer than the deglitch time of t $_{\rm (SG_deg)}$, the device asserts a short-to-GND fault on this channel. During the deglitch time period, if V_{SENSEx} rises above $V_{(SG-th fallina)}$, the timer is reset.

If a fault is detected, a constant-current source pulls the fault bus down. If FAULT is low, all devices connected to the fault bus are off in the fault mode.

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8.3.7.2 LED Short-to-GND Auto Retry

Once the channel has asserted a short-to-GND fault, it automatically retries periodically. In PWM mode, the device sources $I_{(Retv_short)}$ through the SENSEx pin to pull up the LED loads with a pulse duration of t_(SG_retry_ON). The device waits for $\bar{t}_{(SG_retry_OFF)}$ until the next retry pulse. Once auto retry detects that the short-to-GND fault is removed, the device resumes normal operation. During auto retry mode, the device ignores PWM inputs.

8.3.7.3 LED Open-Circuit Detection

The TPS92830-Q1 device has channel-independent LED open-circuit detection. Once an LED open-circuit failure is detected, the device turns off the faulty channel and retries automatically. If the retry mechanism detects that the LED open-circuit fault is removed, the device resumes normal operation.

The device monitors MOSFET dropout voltage differences between the ISNx and SENSEx pins. Voltage difference V_(ISNx) – V_(SENSEx) is compared with internal reference voltage V_(OPEN_th_rising) to detect an LED opencircuit failure. If $\vee_{(ISNx)}$ – $\vee_{(SENSEx)}$ falls below the $\vee_{(OPEN_th_rising)}$ voltage and it stays there longer than the deglitch time of t_(OPEN_deg), the device asserts an open-load fault on this channel. During the deglitching time period, if $V_{(ISNx)} - V_{(SENSEx)}$ rises above $V_{(OPEN_th_falling)}$, the deglitch timer is reset.

In normal operation, the N-channel MOSFET operates in the saturation region with a gate-source voltage close to its threshold voltage. In this case, the drain-source voltage of the N-channel MOSFET is typically much higher than open-circuit threshold $V_{(OPEN_th_rising)}$. In the LED open-circuit condition, the N-channel MOSFET operates in the linear region with a gate-source voltage much higher than its threshold voltage. The N-channel MOSFET is fully on.

If a fault is detected, a constant-current source pulls the fault bus down. If the FAULT pin is low, all devices connected to the fault bus are off in the fault mode.

8.3.7.4 LED Open-Circuit Auto Retry

Once the channel has asserted an open-circuit fault, it automatically retries periodically. The device sources $I_{(Retry\ open)}$ through the SENSEx pin to pull up the LED loads with a pulse duration of $t_{(OPER\ review\ ON)}$. In PWM mode, the device waits for $t_{\text{OPEN return OFF}}$ until the next retry pulse. Once auto retry detects that the open-circuit fault has been removed, the device resumes normal operation. During auto retry mode, the device ignores PWM inputs. In the open-circuit scenario, the retry current cannot find a path to ground; thus, total current consumption does not increase.

8.3.7.5 Dropout-Mode Diagnostics

When the input voltage is not high enough to keep the external N-channel MOSFET in the constant-current saturation region, the TPS92830-Q1 device tries to regulate current by driving the external N-channel MOSFET in the linear region. This state is called the dropout mode, because voltage across the sense resistor is not able to reach the regulation threshold.

In dropout mode, LED open-circuit detection must be disabled via the DIAGEN input. Otherwise, the dropout mode would be treated as an LED open-circuit fault. The DIAGEN pin is used to avoid false diagnostics on an output channel due to low supply voltage.

When the DIAGEN voltage is low, the LED open-circuit detection is ignored. When the DIAGEN voltage is high, LED open-circuit detection resumes normal operation.

In dropout mode, the MOSFET is driven at maximum gate-source voltage to regulate current to the desired value. When the supply voltage increases, the MOSFET gate voltage is pulled down internally by a control loop. If the supply-voltage slew rate is fast, a high-current pulse can be observed on the LED for a short period of time. At the same time, the current-sense voltage may exceed the normal operating range and damage internal circuitry. A parallel diode or a current-limiting resistor less than 1 kΩ is recommended to clamp the voltage across the sensing resistor in the case of a large pulse current.

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图 **30. Resistor and Diode for Sense-Resistor Protection**

8.3.7.6 Overtemperature Protection

The TPS92830-Q1 device monitors device junction temperature. When the junction temperature reaches the thermal shutdown threshold $T_{(TSD)}$, all outputs shut down and the charge pump also stops working. Once the junction temperature falls be<u>low T_(TSD) – T_(TSD_HYS), the device resumes normal operation. During</u> overtemperature protection, the FAULT bus is pulled low.

8.3.7.7 FAULT Bus Output With One-Fails–All-Fail

The TPS92830-Q1 device has a FAULT bus for diagnostics output. It also supports a one-fails–all-fail function with other TPS92830-Q1, TPS9261x-Q1, TPS92630-Q1, or TPS92638-Q1 devices.

In normal operation, FAULT is weakly pulled up by internal pullup current source $I_{(FAULT\hbox{ bullto})}$ to a voltage higher than $V_{OH(FAULT)}$. If any fault scenario occurs, the FAULT bus is strongly pulled low by internal pulldown current source $I_{(FAULT)$ _{ulldown}). Once V_(FAULT) falls below V_{IL(FAULT)}, all outputs are shut down for protection. The faulty channel keeps retrying until the fault condition is removed. The charge pump is shut down, and current consumption is also reduced to $I_{(FAULT)}$ to save quiescent current.

If \overline{FAULT} is externally pulled up with a current higher than $I_{(FAULT_pulldown)}$, the one-fails–all-fail function is disabled and only the faulty channel is turned off. The charge pump remains operating normally, and the device is in normal operation mode. The FAULT bus is able to support up to 15 pieces of TPS92830-Q1, TPS92630-Q1, TPS92638-Q1, or TPS9261x-Q1 devices.

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8.3.7.8 Fault Table

表 **3. Fault Table With DIAGEN = HIGH**

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表 **4. Fault Table With DIAGEN = LOW**

8.4 Device Functional Modes

8.4.1 Undervoltage Lockout, V(IN) < V(UVLO)

When the device is in undervoltage lockout mode, the TPS92830-Q1 device disables all functions until the supply rises above the UVLO-rising threshold. The device pulls down the Gx outputs. Other outputs are in the highimpedance state.

8.4.2 Normal Operation ($V_{(IN)} \ge 4.5$ V, $V_{(IN)} > V_{(LED)} + 0.5$ V)

The device drives an LED string in normal operation. A 0.5-V minimal dropout voltage is typically more than enough to maintain LED current regulation.

8.4.3 Low-Voltage Dropout

When the device drives an LED string in low-dropout mode, even with the MOSFETs fully turned on the output current may not reach target value. The device reports an LED open-circuit failure if DIAGEN is HIGH.

8.4.4 Fault Mode (Fault Is Detected)

When the device detects an open or shorted LED, the device tries to pull down the FAULT pin with a constant current. If the fault bus is pulled down, the device switches to fault mode and consumes a fault current of $I_{(FAll T)}$.

9 Application and Implementation

注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

In automotive applications, linear LED drivers are preferable for various applications, especially exterior lighting, for their simplicity and electromagnetic compatibility. This section provides a few examples to show the design process for different features.

9.2 Typical Applications

9.2.1 Typical Application for Automotive Exterior Lighting With One-Fails–All-Fail

Various functions of exterior lighting may use the following circuit. Here is a typical application circuit for a turn indicator. A TPS92830-Q1 drives a total of nine LEDs with 3s3p configuration at 300 mA each.

9.2.1.1 Design Requirements

With the wide range of battery voltages in modern automotive systems, it is a common requirement among car OEMs to turn LEDs off when the battery voltage is below the minimal voltage threshold, for example, 6 V.

When the battery voltage is between 6 V and 9 V, LEDs may not achieve full brightness due to low input voltage. Although a linear LED driver may drive in low-dropout mode, it is required not to treat the low-dropout mode as an open-circuit fault and to report a false error.

Typical Applications (接下页**)**

When battery voltage ranges between 9 V and 16 V, the LED driver works in normal mode with the one-fails–allfail feature. If any LED strings fail with an open circuit or short circuit, the TPS92830-Q1 device pulls down the fault bus. All devices connected to the same fault bus turn off their outputs.

When the battery voltage is above 18 V, the TPS92830-Q1 device is able to detect the overvoltage and derate the output current to reduce the power dissipation of the MOSFETs and prevent thermal damage.

9.2.1.2 Detailed Design Procedure

Fixed Parameters

- Charge pump flying capacitor $C6 = 10$ nF
- Charge pump flying capacitor $C8 = 10$ nF
- $R_{(IREF)} = 8 k\Omega$
- Charge pump storage capacitor $C10 = 150$ nF

Current Setting

- $I_{(I,ED)} = 300$ mA
- $R_{(SNS)} = V_{(CS-REG)} / I_{(LED)} = 0.983 \Omega$

PWM Threshold Setting

- PWM enables when $V_{(1N)} > 6 V$
- $K_{(RES~PWM)} = V_{IH(PWMx, max)} / 6 V$
- $K_{(RES~PWM)} = R15 / (R15 + R8)$
- Set R15 = 20 kΩ, R8 = 76 kΩ

DiagEN Setting (Enables LED-Open Detection When $V_{(IN)} > 9$ V

- $K_{(RES_DiagEN)} = V_{IH(DIAGEN, max)} / 9 V$
- $K_{(RES\ DiaqEn)} = R13 / (R6 + R13)$
- Set R13 = 10 kΩ, R6 = 62 kΩDiagEN setting

DERATE Setting (Reduces Current Output When $V_{(IN)}$ > 18 V

- $K_{(RES_DERATE)} = V_{(DERATE_FULL, min)} / 18 V$
- $K_{(RES\ DERATE)} = R7 / (R7 + R14)$
- Set R7 = 10 k Ω , R14 = 95 k Ω

To deliver 300 mA with a single MOSFET package, the designer must consider the maximum thermal-dissipation condition. The power dissipation of a MOSFET is usually at its peak when input voltage is at 16 V in a fullbrightness condition. Assume the minimal LED forward voltage at 300 mA is 6 V.

$$
P_{(MOSFET)} = I_{(LED)} \times \left(V_{(IN)} - V_{F(Diode)} - V_{F(LED,min)} - V_{(CS_REG)}\right) = 300mA \times (16-0.7-6-0.295) = 2.702W
$$
\n(10)

MOSFET package and layout design must be considered to dissipate 2.702 W at maximum ambient temperature, usually 85°C.

The TPS92830 device can support a variety of N-channel MOSFETs in the markets. Adding a capacitor between the gate and source increases the loop phase margin. The recommended total capacitance at Gx is greater than 4 nF.

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Typical Applications (接下页**)**

9.2.1.3 Application Curves

9.2.2 High-Precision Dual-Brightness PWM Generation

9.2.2.1 Dual-Brightness Application

Automotive lighting often reuses the same LEDs for different functions with different brightness, for example, daytime running lights (DRL) and position lights, or stop and tail lights. Analog dimming by changing the constant current may affect LED color temperature. PWM dimming could easily achieve the dimming ratio with the same color temperature.

The TPS92830-Q1 device provides a precision PWM generator with a synchronization PWMOUT output. Its integrated high-precision PWM generator ensures homogeneity across different devices.

Typical Applications (接下页**)**

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图 **33. PWM Generator Master-Slave Configuration**

9.2.2.2 Design Requirements

When full duty-cycle (FD) is HIGH, the output is at 100% duty cycle.

When full duty-cycle (FD) is LOW, the output is at 10% duty cycle and 250 Hz.

9.2.2.3 Detailed Design Procedure

PWM Equations

- $R_{PU} = 10 kΩ$
- $C_{\text{PWM}} = 105.5 \text{ nF}$
- $R_{\text{PWM}} = 55.5 \text{ k}\Omega$

Typical Applications (接下页**)**

9.2.2.4 Application Curve

9.2.3 Driving High-Current LEDs With Parallel MOSFETs

Thermal performance is one key consideration in automotive exterior driving, especially for a linear LED driver. Due to large variations of automotive battery voltage, a linear LED driver must accommodate thermal dissipation with a worst-case scenario, which is high ambient temperature and high battery voltage.

LED driver thermal dissipation performance merely depends on the package and PCB thermal dissipation area. However, if the thermal dissipation performance of a single MOSFET is not able to support the required LED string current, multiple MOSFETs in parallel are able to dissipate heat for high-current applications.

When a MOSFET is in the saturation region as a current-control device, its current output strongly depends on its threshold. MOSFET threshold V_{th} can vary from one device to another. When MOSFETs are in parallel, even a small threshold mismatch could lead to imbalance of current distribution.

With an integrated charge pump, the TPS92830-Q1 device provides sufficient headroom even when the supply voltage is as low as 5 \check{V} . Thus adding ballast resistors between the N-channel MOSFET source and the LED string introduces negative feedback for each parallel MOSFET path to balance the current flows.

 $V_{(IN)}$ = 16 V, $I_{(Total)}$ = 964 mA, T_A= 25 °C.

图 **36. Parallel MOSFET Driving**

9.2.3.1 Application Curves

10 Layout

10.1 Layout Guidelines

The TPS92830-Q1 device relies on external MOSFETs to dissipate heat for high-current applications. To effectively dissipate heat on MOSFETs and LEDs, TI recommends to use 0.071-mm-thick (2-oz.) copper PCBs or metal-based boards. Make the thermal dissipation area with copper as large as possible. Place thermal vias on the thermal dissipation area to further improve the thermal dissipation capability. The current path starts from IN through the sense-resistors, MOSFETs, and LEDs to GND. Wide traces are helpful to reduce parasitic resistance along the current path as shown in the layout example below.

Place capacitors, especially charge pump capacitors, close to the device to make the current path as short as possible. TI suggests keeping the LED high-current ground path separate from device ground. TI also recommends kelvin-connection to the connector. The following layout example shows the recommended guidelines.

10.2 Layout Example

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图 **38. TPS92830-Q1 Example Layout Diagram**

11 器件和文档支持

11.1 接收文档更新通知

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11.5 Glossary

[SLYZ022](http://www.ti.com/cn/lit/pdf/SLYZ022) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 机械、封装和可订购信息

以下页面包含机械、封装和可订购信息。这些信息是针对指定器件提供的最新数据。本数据随时可能发生变更并且 不对本文档进行修订,恕不另行通知。要获得这份数据表的浏览器版本,请查阅左侧的导航窗格。

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(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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PACKAGE MATERIALS INFORMATION

*All dimensions are nominal

PW (R-PDSO-G28)

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 $\hat{\mathbb{C}}$ Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

 $\hat{\mathbb{D}}$ Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

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